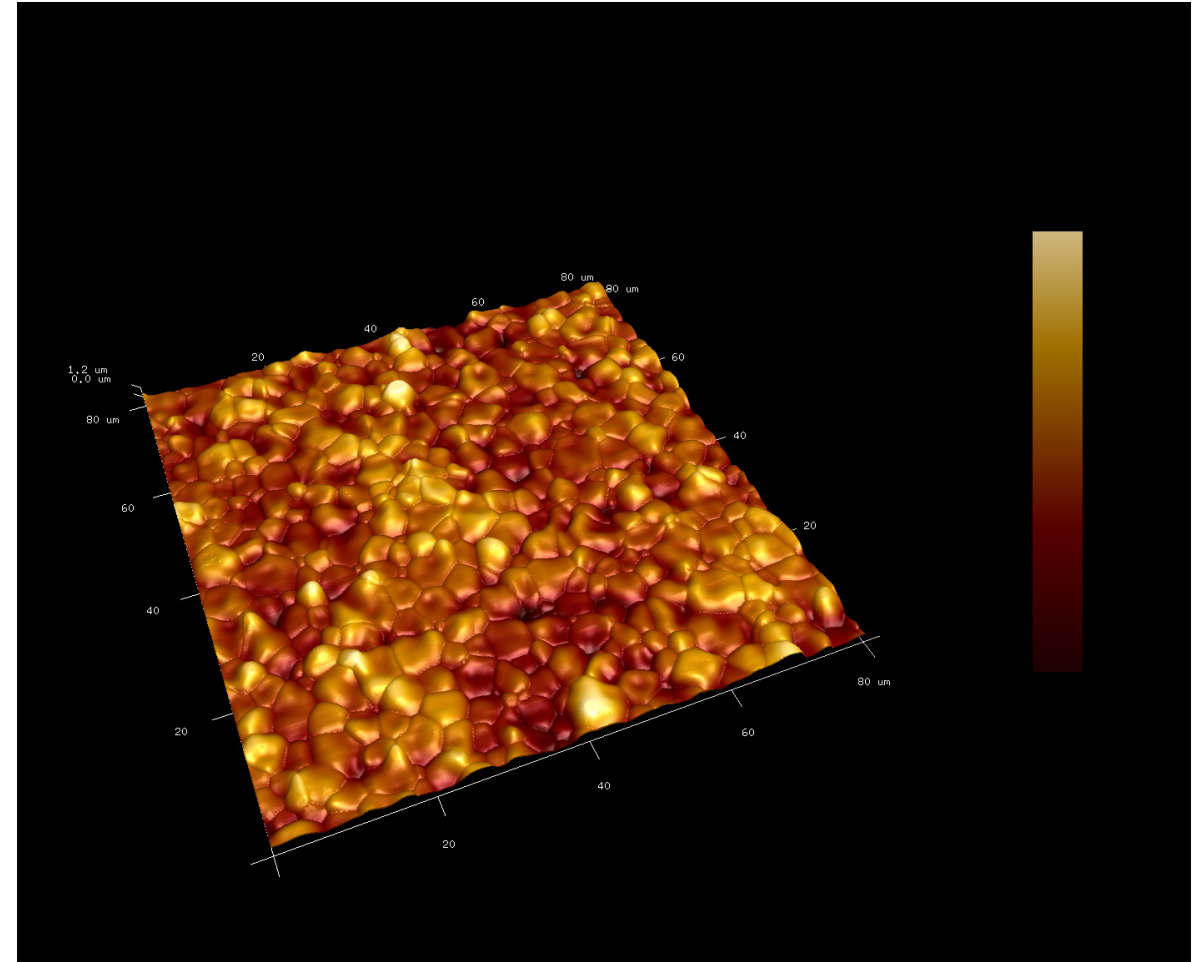


# Surface Roughness Reduction and Performance of Nb<sub>3</sub>Sn thin-film for SRF Applications



U. Pudasaini, C. E. Reece, E. Lechner,  
M. J. Kelley, A.M. Valente-Feliciano, O. Trofimova

Saturday, August 19, 2023

# Outline

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- Nb<sub>3</sub>Sn and Sn vapor diffusion technique
- Surface roughness – evolution and characteristics
- Roughness and cavity performance
- Roughness reduction
- Cavity results
- Summary and Outlook

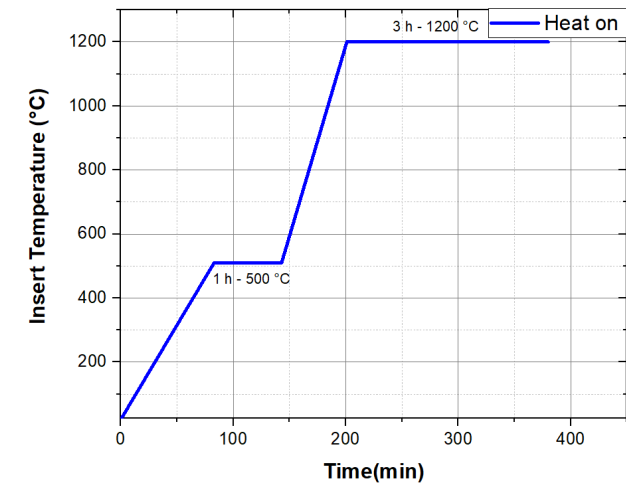
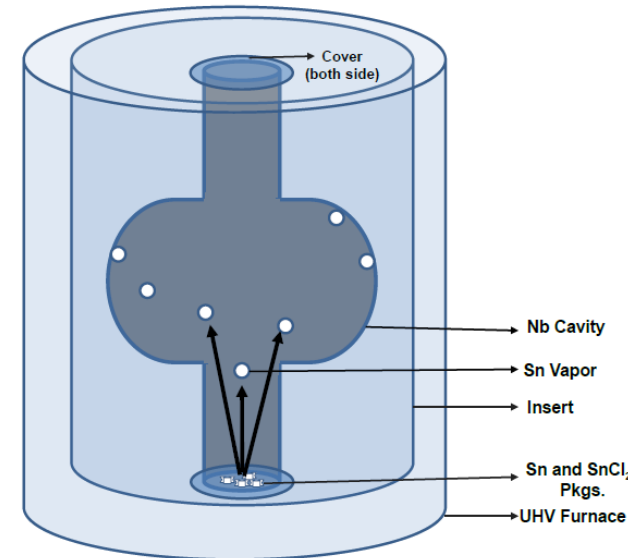
# Vapor diffused Nb<sub>3</sub>Sn thin film for SRF cavity

- Higher  $T_c$  and  $H_{sh}$  of Nb<sub>3</sub>Sn promise better RF performance ( $Q_0$  and  $E_{acc}$ ) and/or higher operating temperature (2 K vs 4.3 K)

	Nb	Nb <sub>3</sub> Sn
$T_c$ (K)	9.25	18.3
$H_{sh}$ (mT)	220	425
$Q^{BCS}$ at 2 K	$5 \times 10^{10}$	$5 \times 10^{14}$
$Q^{BCS}$ at 4 K	$5 \times 10^8$	$5 \times 10^{10}$
$E_{acc}$ (MV/m)	50	100

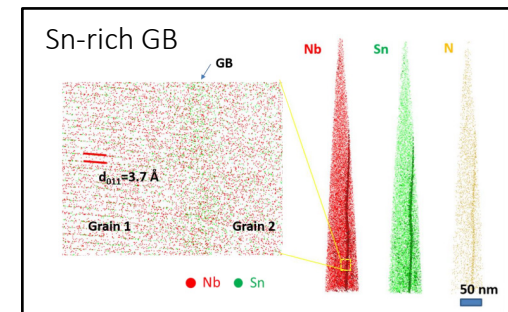
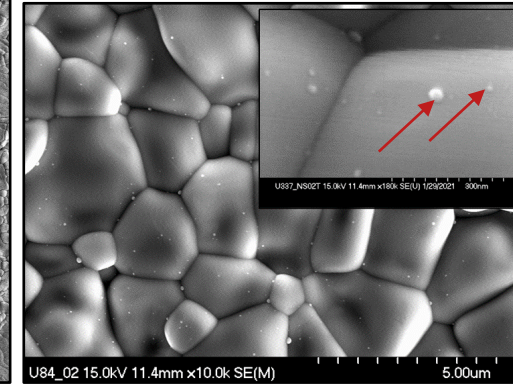
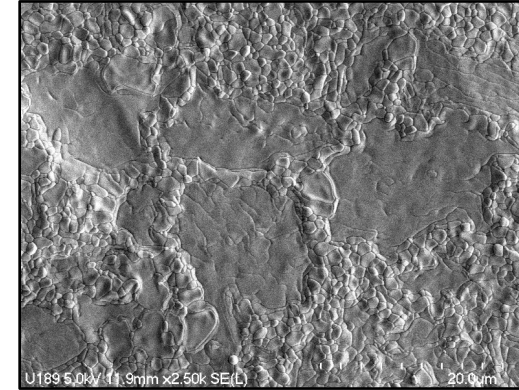
- Vapor diffusion Technique

- Create Sn vapor, transport it to the interior surface a Nb cavity, and provide suitable temperature environment to grow Nb<sub>3</sub>Sn on Nb.

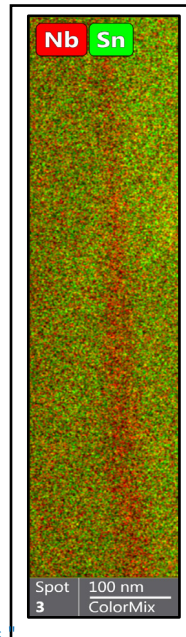


# Performance limiting factors

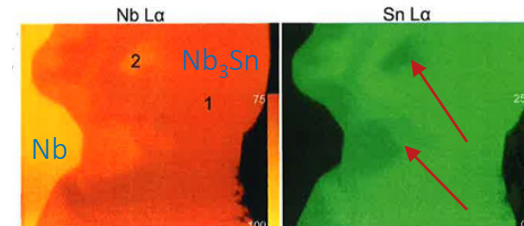
- A few known issues that potentially contribute to performance:
  - Non-uniformity and patchy regions (thin large grains)
  - Accumulation of Sn-residues
  - Incorporated impurities
  - Non-stoichiometric grain boundaries
  - Low-Sn regions
  - **Surface topography (Roughness)**



Sn-deficient GB

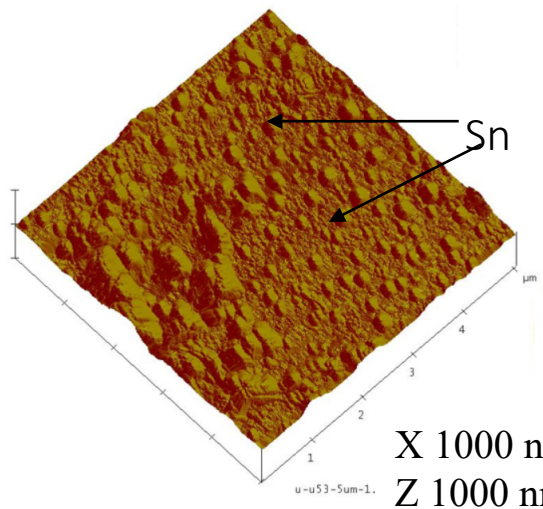
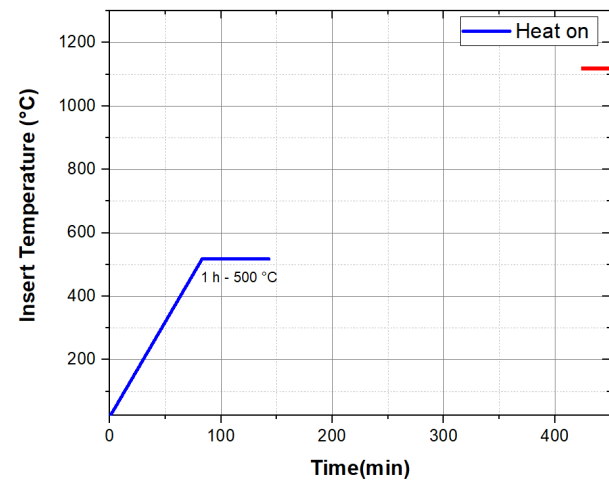


J. Lee, Jaeyel, et al. "Grain-boundary structure and segregation in Nb<sub>3</sub>Sn coatings on Nb for high-performance superconducting radiofrequency cavity applications." *Acta Materialia* 188 (2020): 155-165.

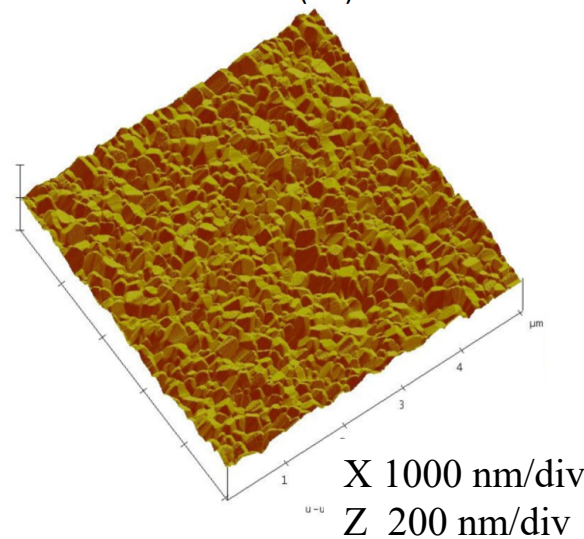
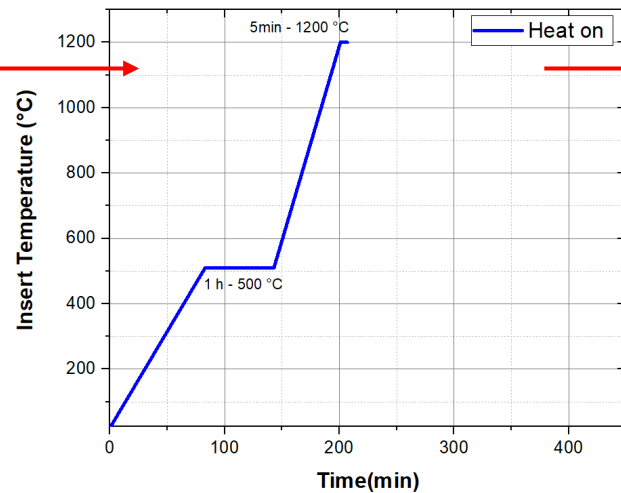


C. Becker et al. "Analysis of Nb<sub>3</sub>Sn surface layers for superconducting radio frequency cavity applications" *Appl. Phys. Lett.* 106, 082602 (2015)  
D. Hall "New insights into the limitations on the efficiency and achievable gradients in Nb<sub>3</sub>Sn SRF cavities" Dissertation. Cornell University 2017.

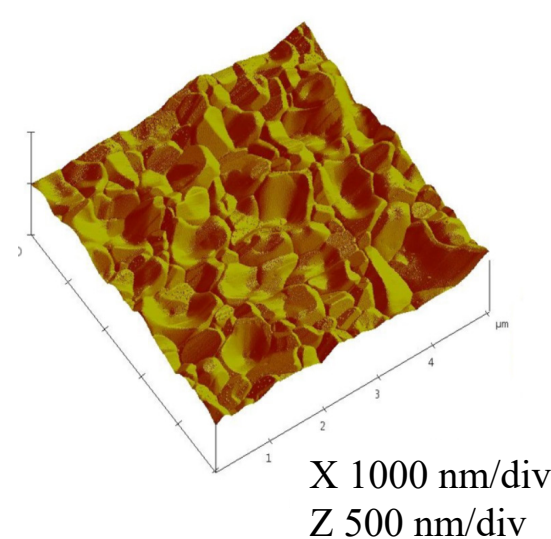
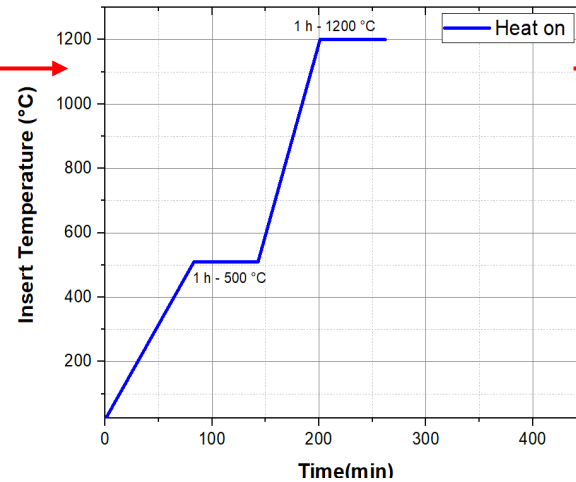
# Roughness evolution during thin film growth



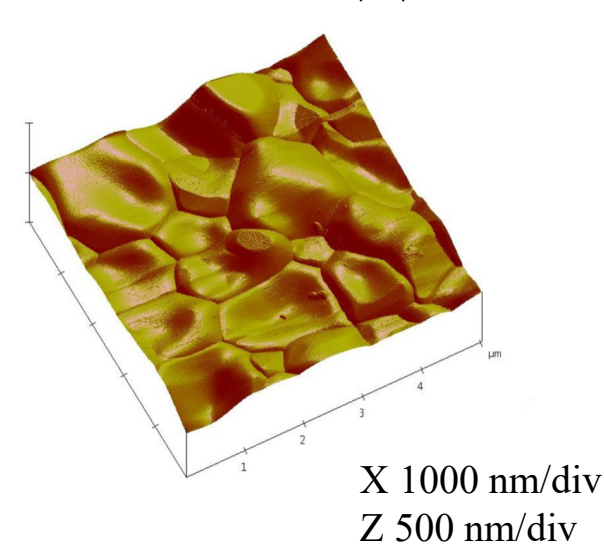
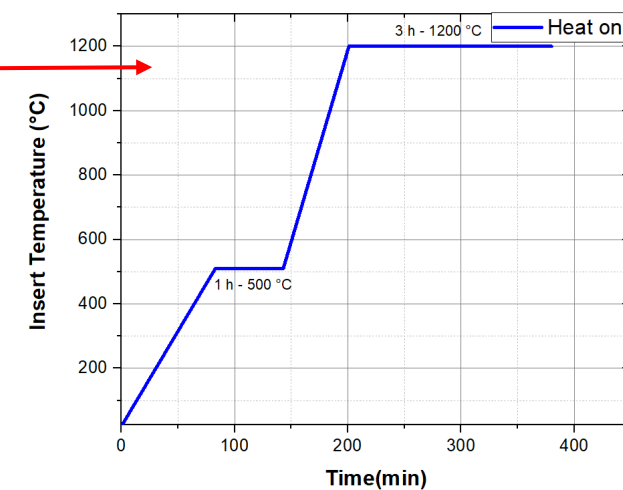
$Ra = 54.8 \pm 9.4 \text{ nm}$



$Ra = 7.3 \pm 0.6 \text{ nm}$



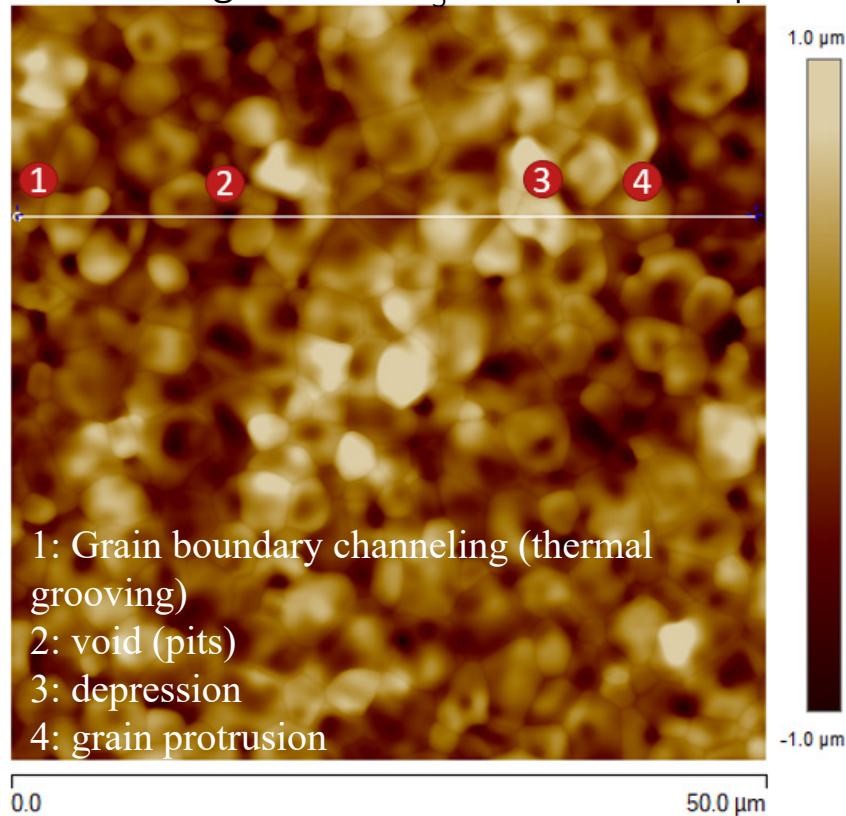
$Ra = 23.6 \pm 4.6 \text{ nm}$



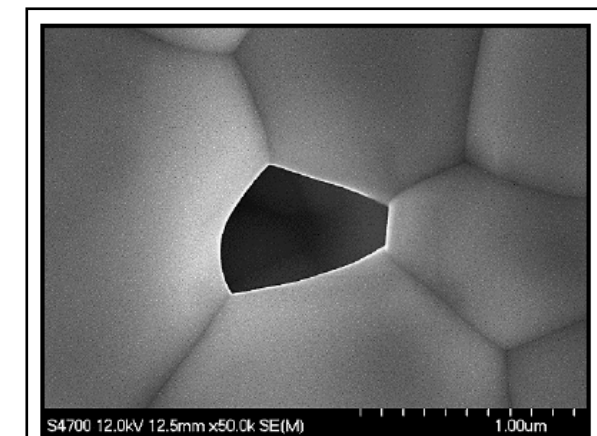
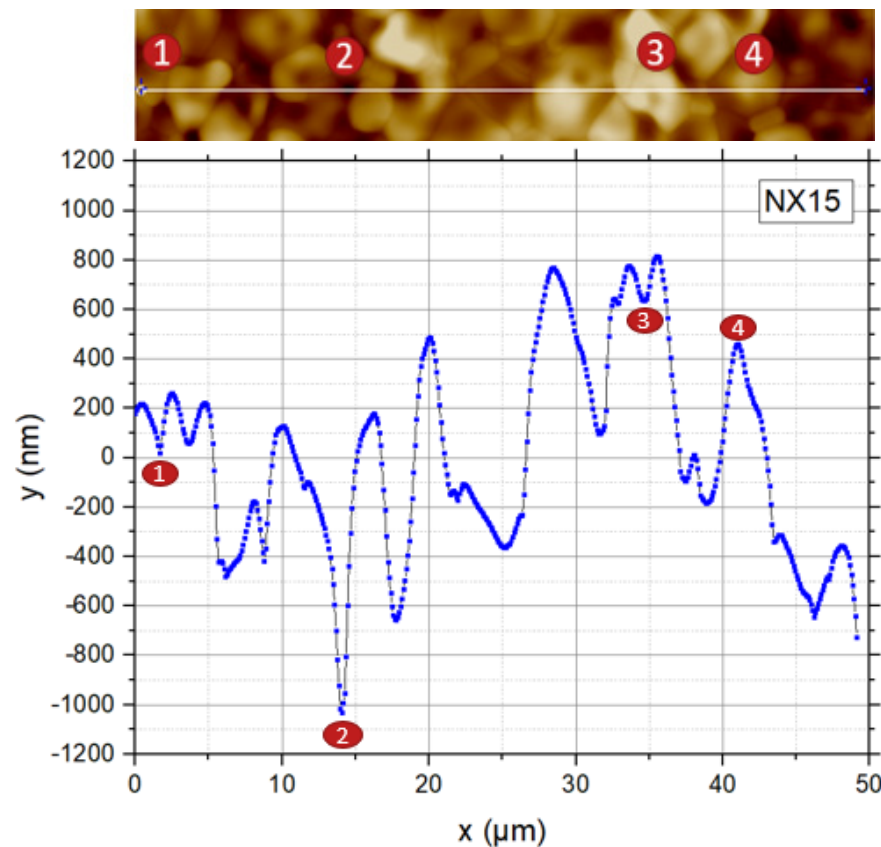
$Ra = 61.8 \pm 4.6 \text{ nm}$

# Roughness in vapor diffused Nb<sub>3</sub>Sn

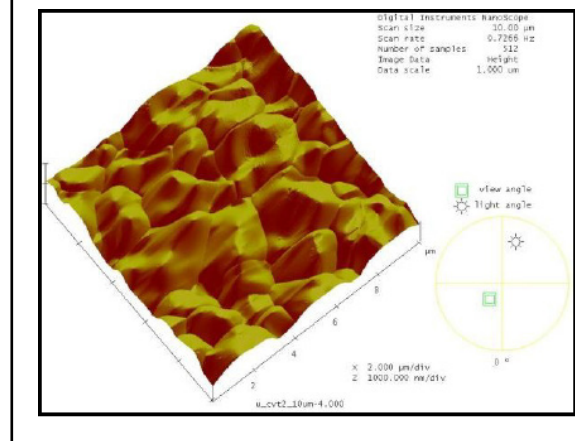
AFM image from Nb<sub>3</sub>Sn-coated sample



Sectional height profile along the white line



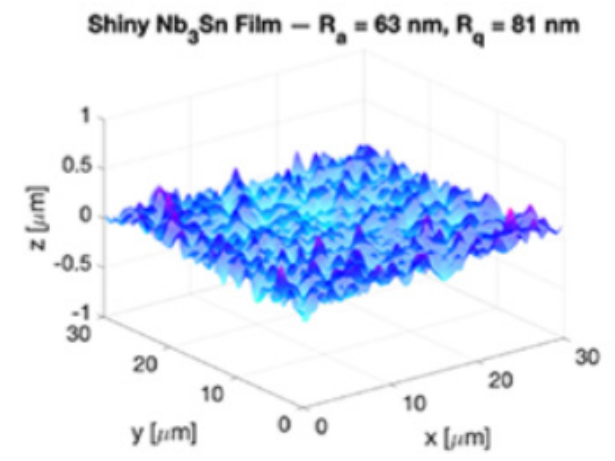
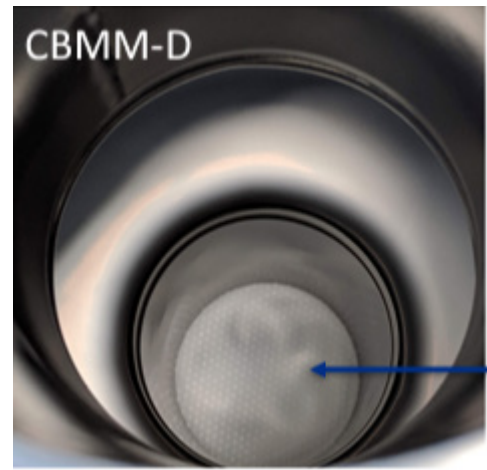
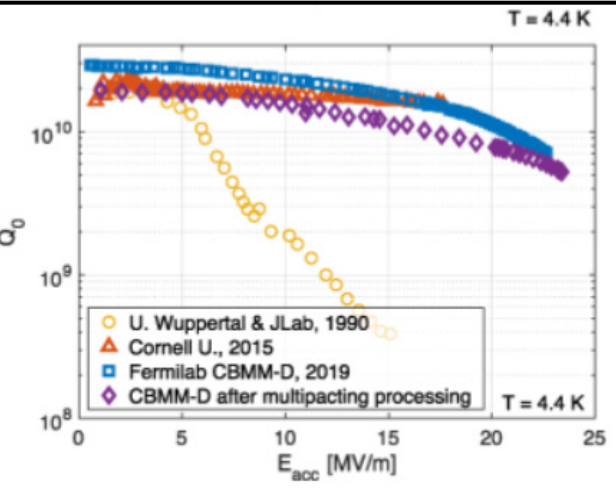
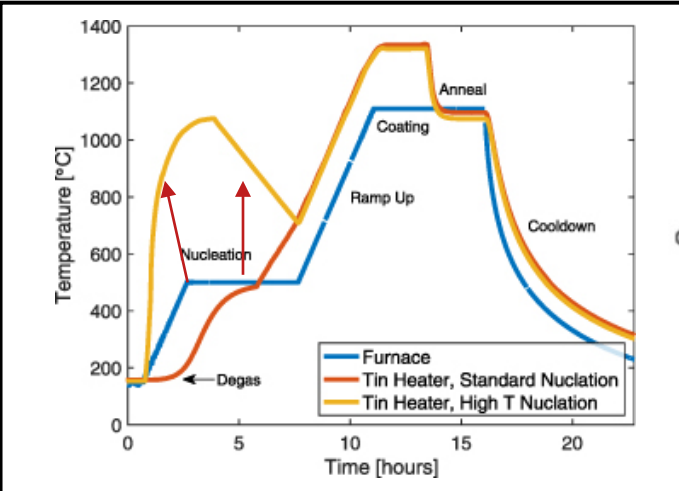
Nb<sub>3</sub>Sn Cavity cutout sample



- Magnetic field enhancement?
- “1% of surface analyzed has field enhancement by more than 45%.” - R. Porter et. al “Surface Roughness Effect on the Performance of Nb<sub>3</sub>Sn” LINAC 2016, MSU,MI)

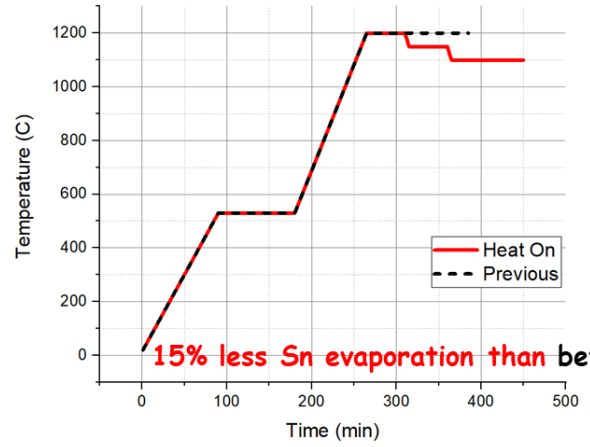
Pudasaini, U., Ereemeev, G.V., Reece, C.E., Tuggle, J. and Kelley, M.J., 2020. Analysis of RF losses and material characterization of samples removed from a Nb<sub>3</sub>Sn-coated superconducting RF cavity. *Superconductor Science and Technology*, 33(4), p.045012.

# Roughness and Cavity Performance



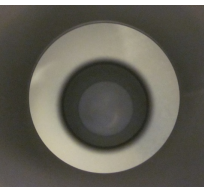
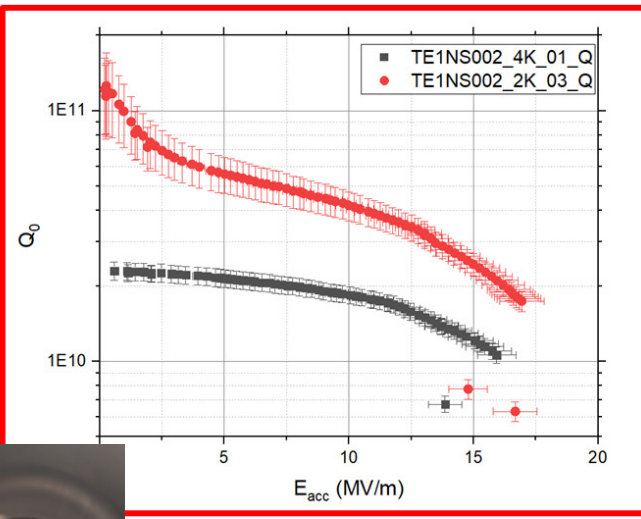
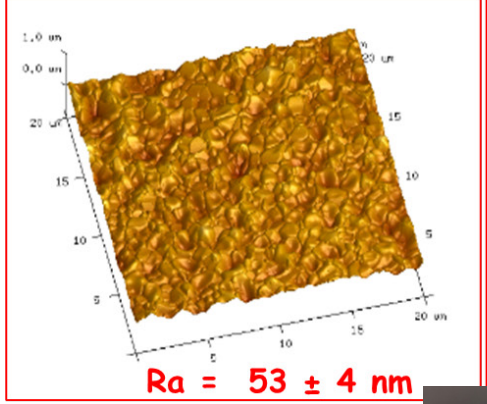
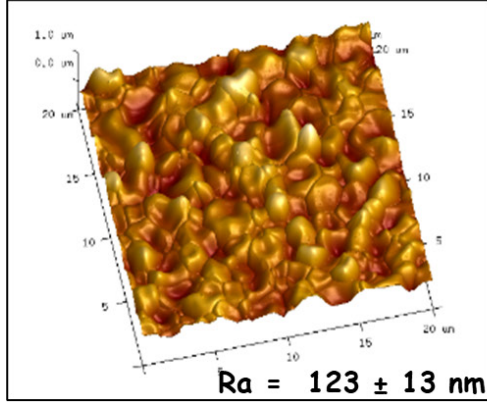
'High-temperature' nucleation

S Posen et. al. 2021 Supercond. Sci. Technol. 34 025007



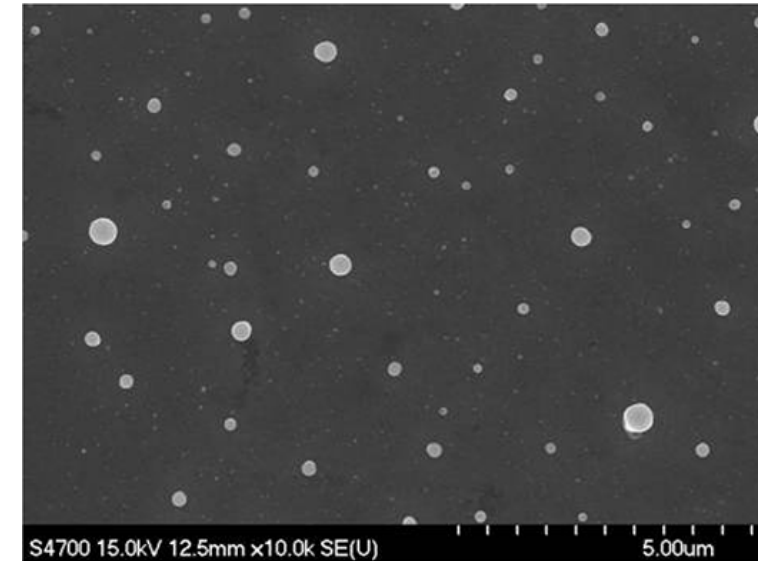
Coating thickness:  $1.2 \pm 0.12 \mu m$   
 Grain size:  $0.96 \pm 0.06 \mu m$

20  $\mu m$   $\times$  20  $\mu m$  AFM Scan



# Roughness reduction

- Nucleation enhancement
  - Reduce the distance between nucleation centers  $\leftrightarrow$  create high-density nucleation sites
  - Nucleation parameter variations – no notable difference in microstructures after the coating
  - Pre-anodization
  - New alternatives
    - High temperature nucleation – need secondary heater (in practice at FNAL)
    - Nucleation enhancement Electrochemical deposition
    - Pre-Sn film deposition
    - Electrochemical thermal deposition (Cornell)
- Tune coating parameters
- Post-coating treatments
  - Mechanical polishing
  - Electrochemical polishing



Nb-surface with typical nucleation



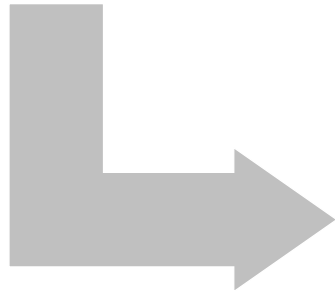
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# **Roughness Reduction by Pre-Sn film deposition**

# Nucleation enhancement with pre-deposition of thin layers of Sn

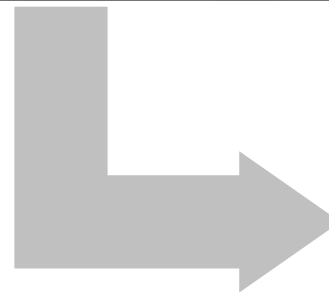
Sample Preparation

- 10 mm × 10 mm samples cut from the same sheet of material
- Bulk BCP 100 μm + 800°C bake + 20 μm final BCP

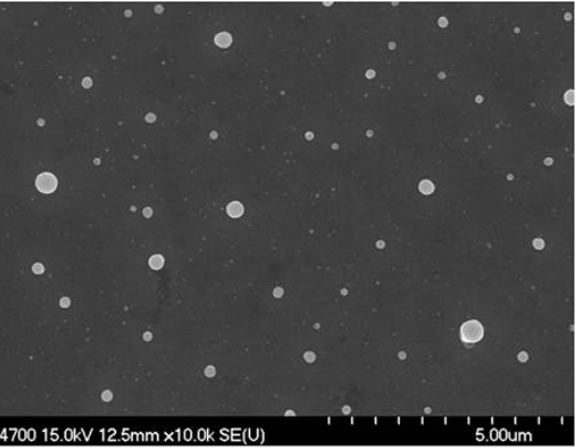


10 or 20 nm Sn Deposition

- Magnetron sputtering



Vapor diffusion process

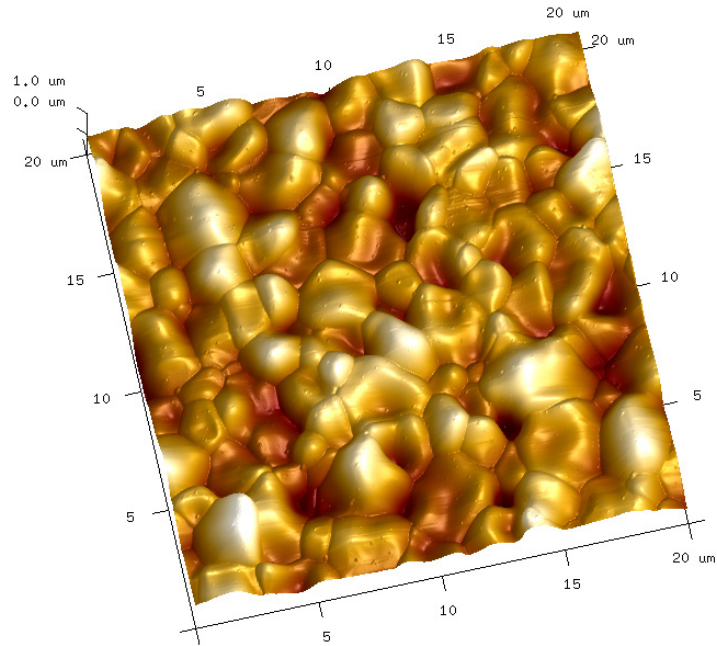


Nb-surface with typical nucleation  
**Goal: grow uniform sized dense grains.**

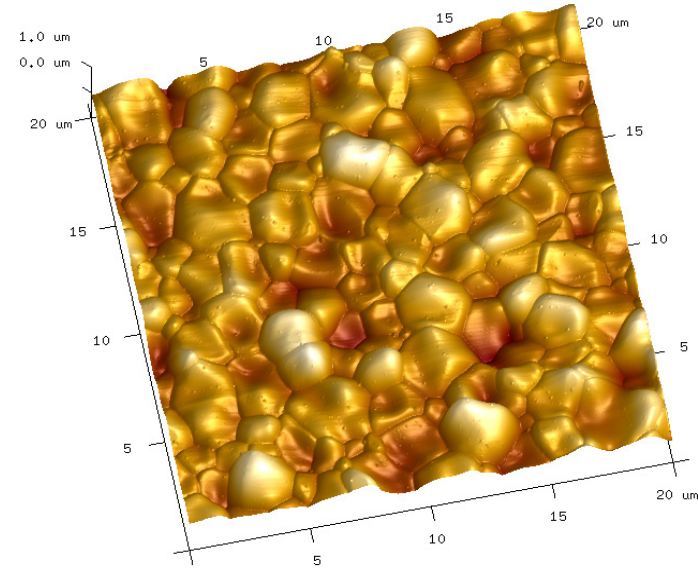
- All samples coated in the same run via vapor diffusion process

# Roughness comparison

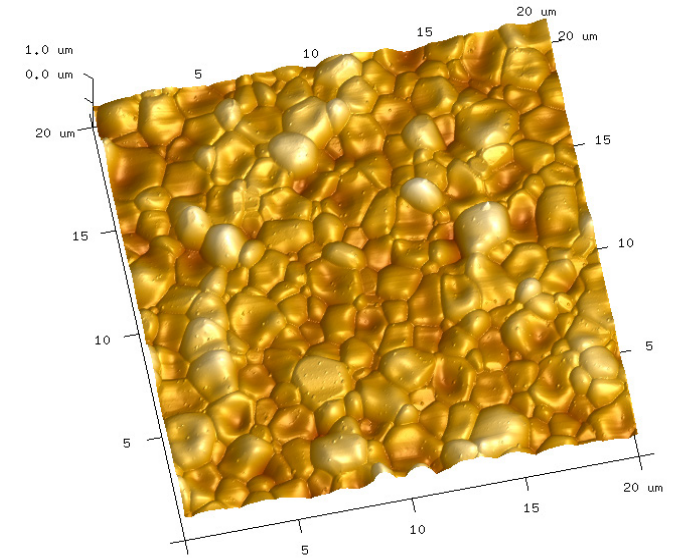
NX11: Nb



X100: 10 nm Sn on Nb

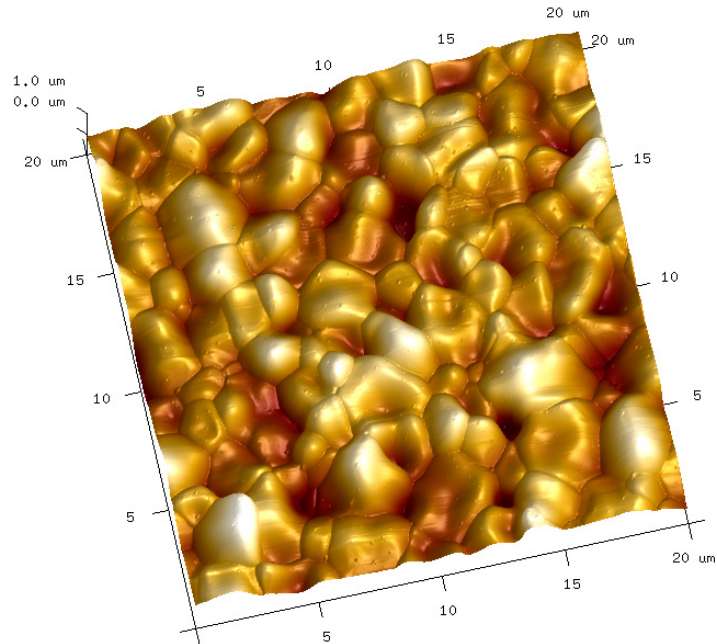


X5: 20 nm Sn on Nb

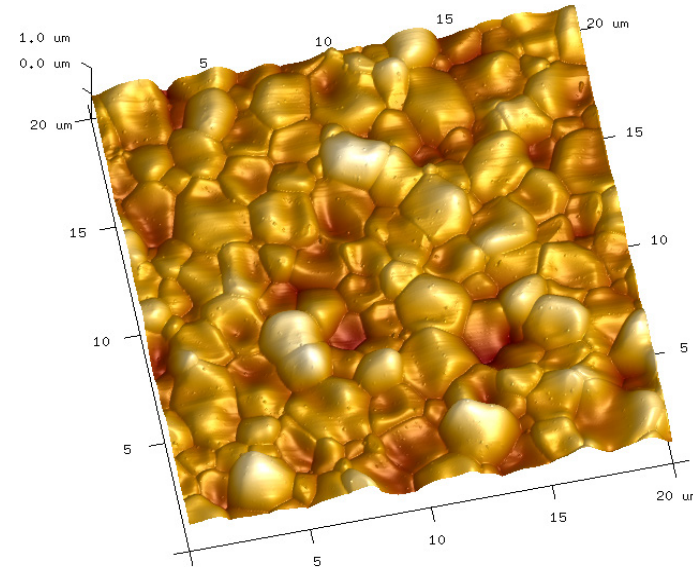


# Roughness comparison

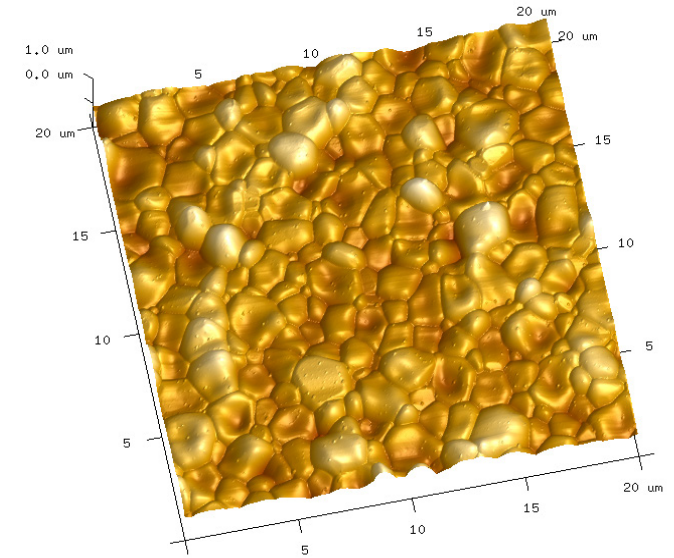
NX11: Nb



X100: 10 nm Sn on Nb



X5: 20 nm Sn on Nb



Samples	Thickness of pre-deposited Sn (nm)	Average grain size ( $\mu\text{m}$ )	Average roughness $R_a$ (nm)
NX11	0	$1.85 \pm 0.14$	$180 \pm 32.4$
X100	10	$1.52 \pm 0.10$	$125 \pm 22.6$
X5	20	$1.26 \pm 0.07$	<b><math>83 \pm 3.1</math></b>

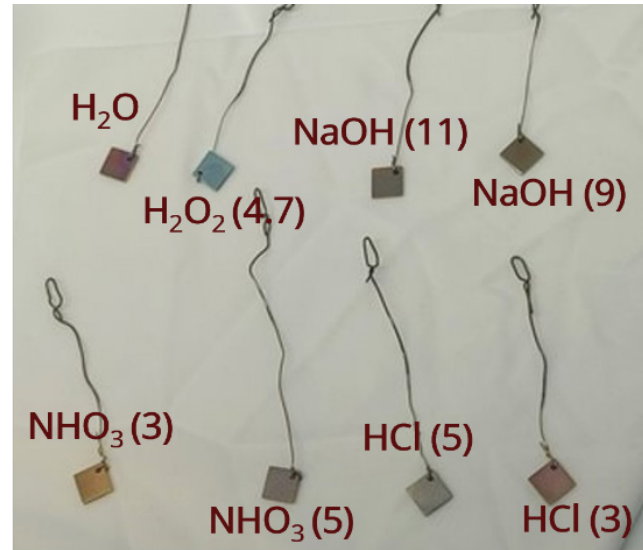
Courtesy of L. Shpani and M. Liepe

## Thin Film Cavity



New coating process (inspired by FNAL shiny cavity) which resulted in lower surface roughness.

## Nucleation Studies

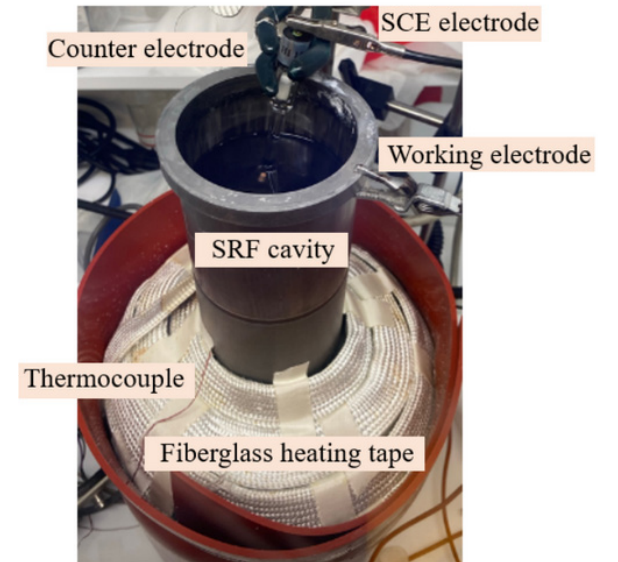


→ Optimizing the nucleation step of vapor diffusion through surface chemistry treatments to achieve smoother films.

Sample studies have shown that chemical treatments pre-nucleation affect the nucleation of Sn onto Nb.

(SUSPB026)

## Electrochemical Deposition



Very promising alternative growth method

→ achieved low surface roughness (~4-5 times lower than vapor diffusion), good stoichiometry, high quality factors and **reduced BCS resistance**. (TUPTB006) *Sun et al.*,

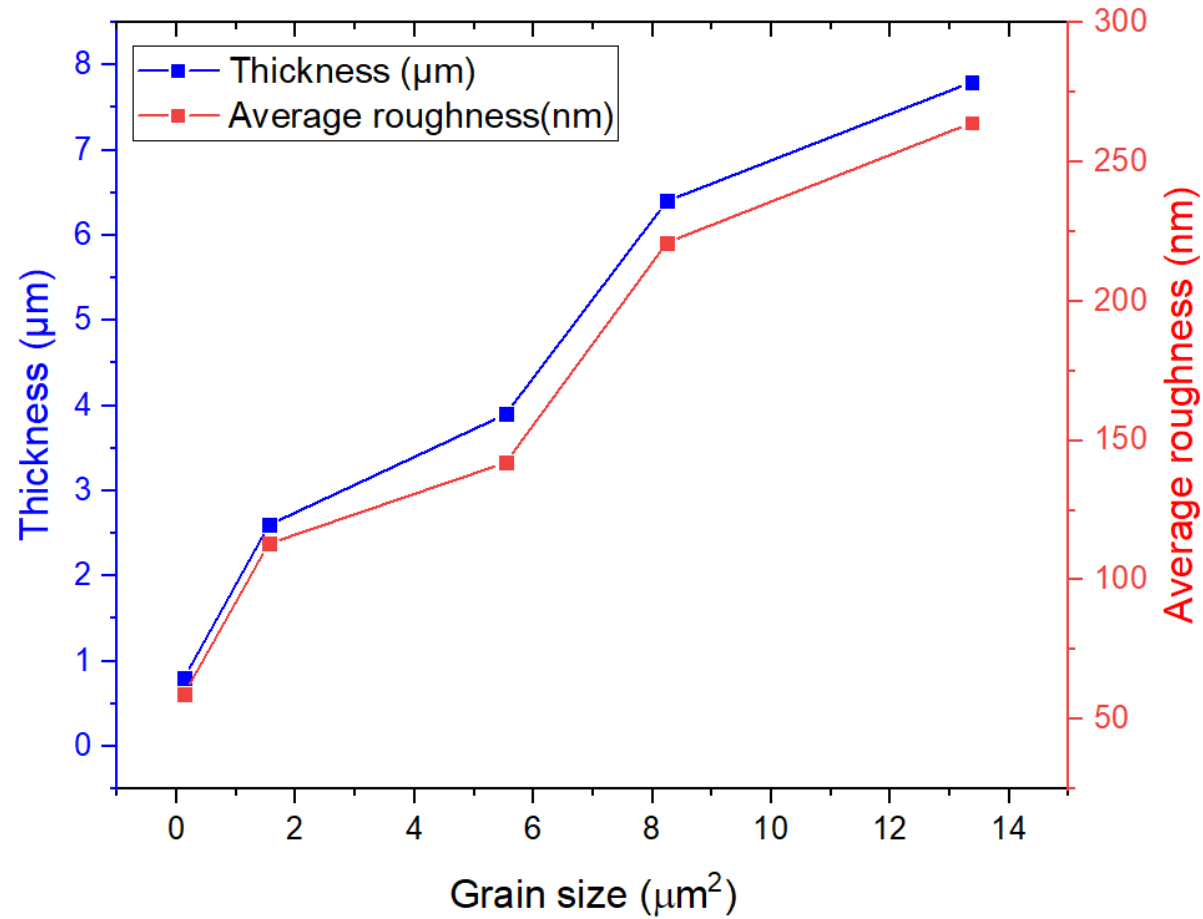
<https://doi.org/10.48550/arXiv.2302.02054>

→ For more details, check out "Development of High-performance Niobium-3 Tin Cavities at Cornell" (WEIAA04)

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# **Roughness Reduction by Tuning Coating Parameters**

# Grain size, thickness, and Roughness

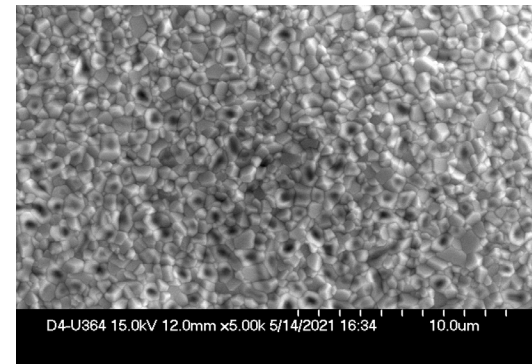
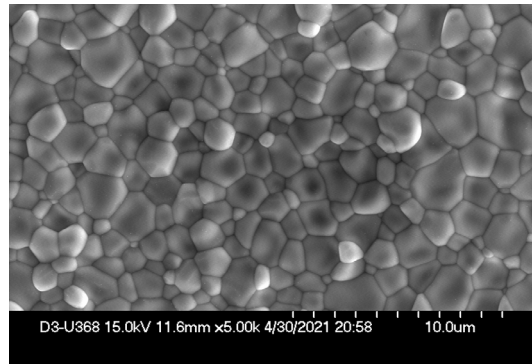
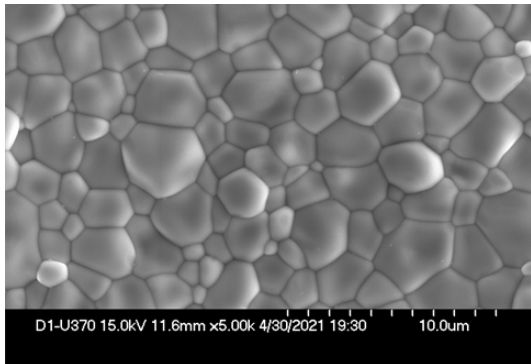


**Positive correlation between the Nb<sub>3</sub>Sn film growth with increasing grain size and the surface roughness.**

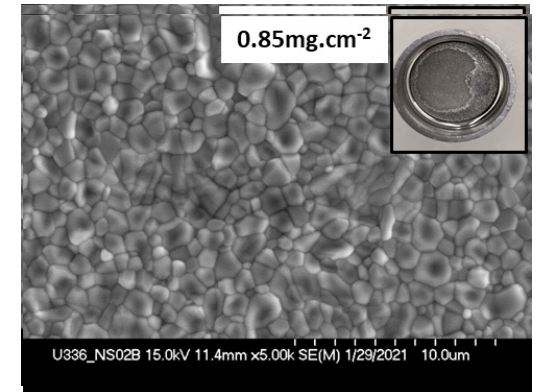
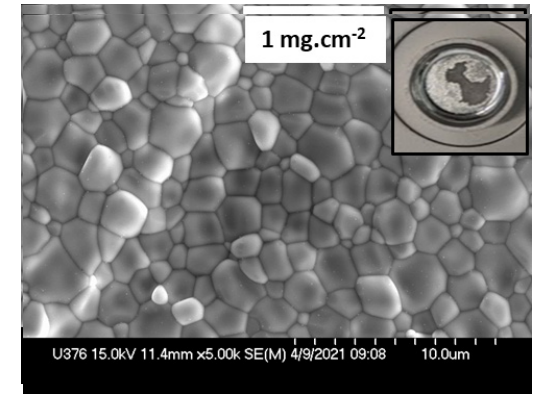
# Tuning Sn-flux

Fixed coating surface area & other coating parameters identical

Diameter (inch)	Cross-sectional area (cm <sup>2</sup> )	Sn use (g)	Grain size (μm)	Average Roughness Ra (nm)
1.0	5.07	0.81	1.63 ± 0.02	126 ± 1.0
0.5	1.27	0.33	1.21 ± 0.06	95.8 ± 3.4
0.25	0.32	0.10	0.56 ± 0.02	28.2 ± 3.3

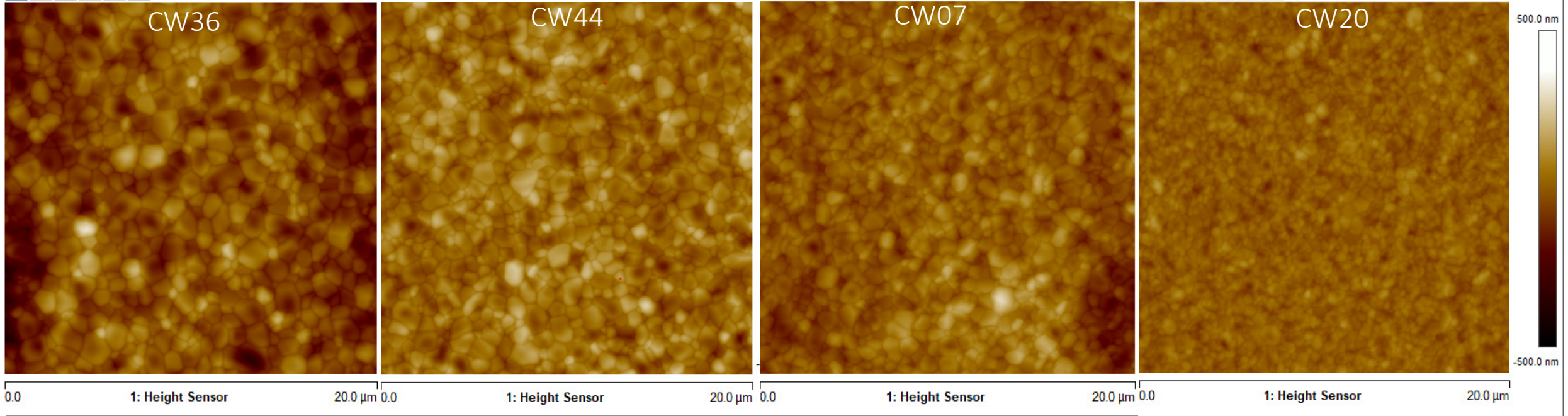


Fixed Sn-source and other coating parameters identical

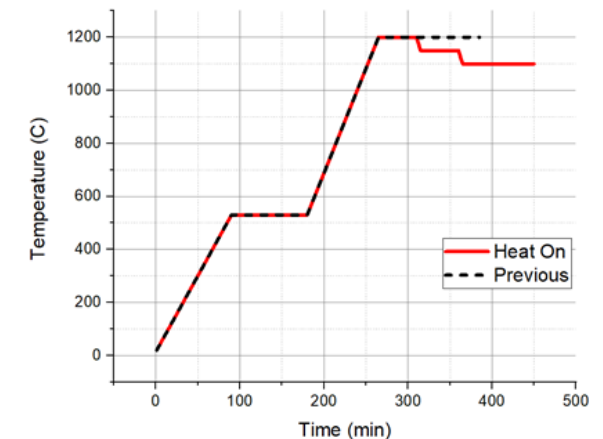




# Variation of temperature profile during the coating stage



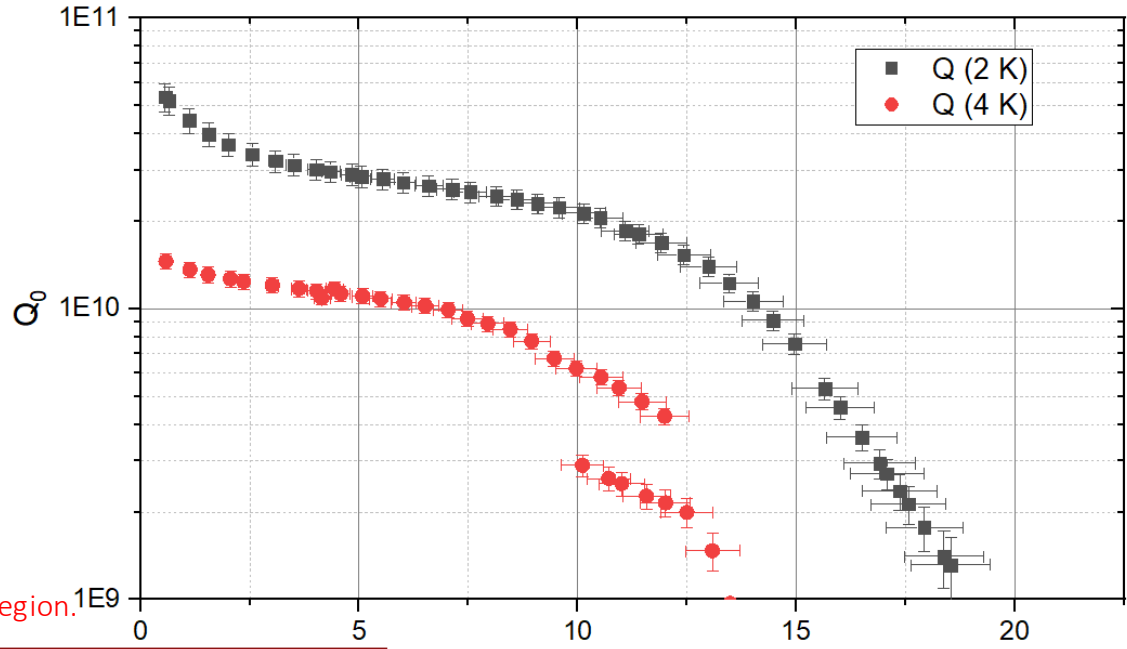
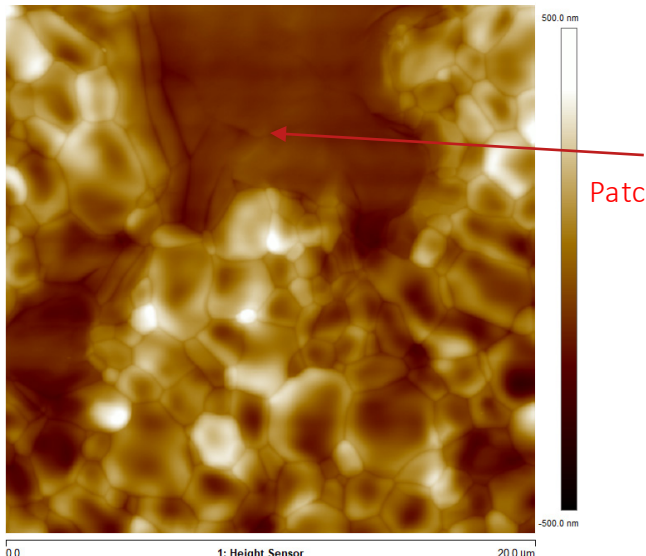
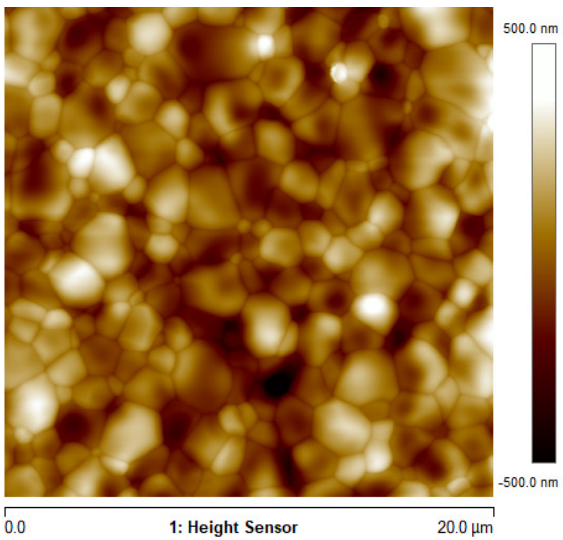
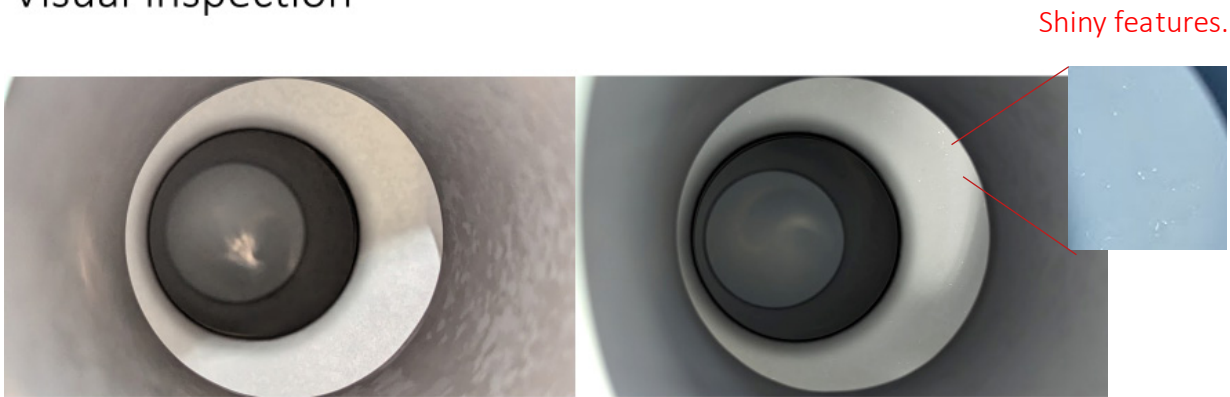
Expt	1200 °C	1150 °C	1100 °C	Sample	R <sub>a</sub> (nm)	Grain size (μm)	Thickness (μm)
01	10 min	45 min	85 min	CW36	69 ± 3	0.93	-
02	10 min	45 min		CW44	40 ± 1	0.75	1.0 +/- 0.2
03	10 min			CW20	27 ± 2	0.55	0.75
04	10 min		85 min	CW07	43.5 ± 1.5	0.6	1.02



# Cavity coating

Expt	1200 °C	1150 °C	1100 °C	Sample	R <sub>a</sub> (nm)	Grain size (μm)	Thickness (μm)
01	10 min	45 min	85 min	CW36	69 ± 3	0.93	-

Visual inspection



Sn-flux was not sufficient.?

Test was limited by input power.

Another cavity coated with slight modification of the coating process is ready to test. Another cavity is ready to coat.

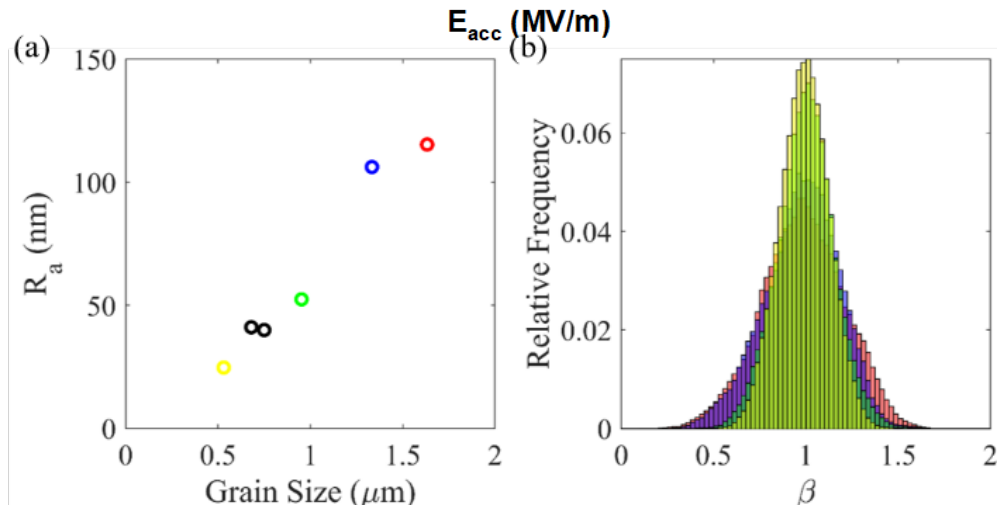
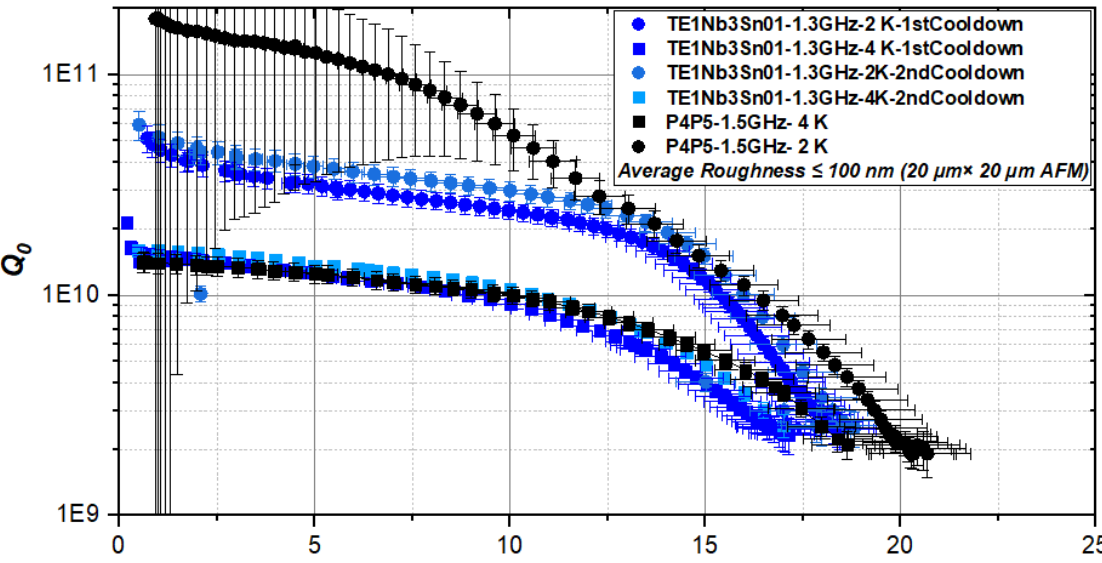
The roughness measured from these samples was 80±10 nm 17

# Cavity Performance

Cavity	Low field Q at 4.3 K	$E_{acc}$ with Q > $10^{10}$ at 4.3 K	Max $E_{acc}$ (MV/m)	Witness sample Ra (nm)
RDT7	$3 \times 10^{10}$	15.5	15.5	$57 \pm 4$
TEN1S002	$2.5 \times 10^{10}$	16.5	17.5	$68 \pm 3$
P4P5#	$1.3 \times 10^{10}$	10	20.7*	$98 \pm 4$
→ TE1NS001	$1.6 \times 10^{10}$	11	18.9	$87 \pm 4$
→ TE1NS001	$2.3 \times 10^{10}$	9.5	16	$102 \pm 16$
→ TE1NS001	$1.7 \times 10^{10}$	9	16.5	$154 \pm 10$
TE1NbSn01	$1.3 \times 10^{10}$	7.5	19.2*	$77 \pm 1$
TE1NbSn02	$1.4 \times 10$	8	18.8*	$80 \pm 10$

#P4P5 – 1.5 GHz cavity                      \* Limited by input power

- Cavities typically attained higher gradients with lower surface roughness, even with patchy regions or Sn residues in a few instances.
- The spread of MFE factors increases with roughness or grain size.
- The improvement in gradient reach is likely to be the result of thinner Nb<sub>3</sub>Sn coating (poor superconductor) and roughness reduction both.

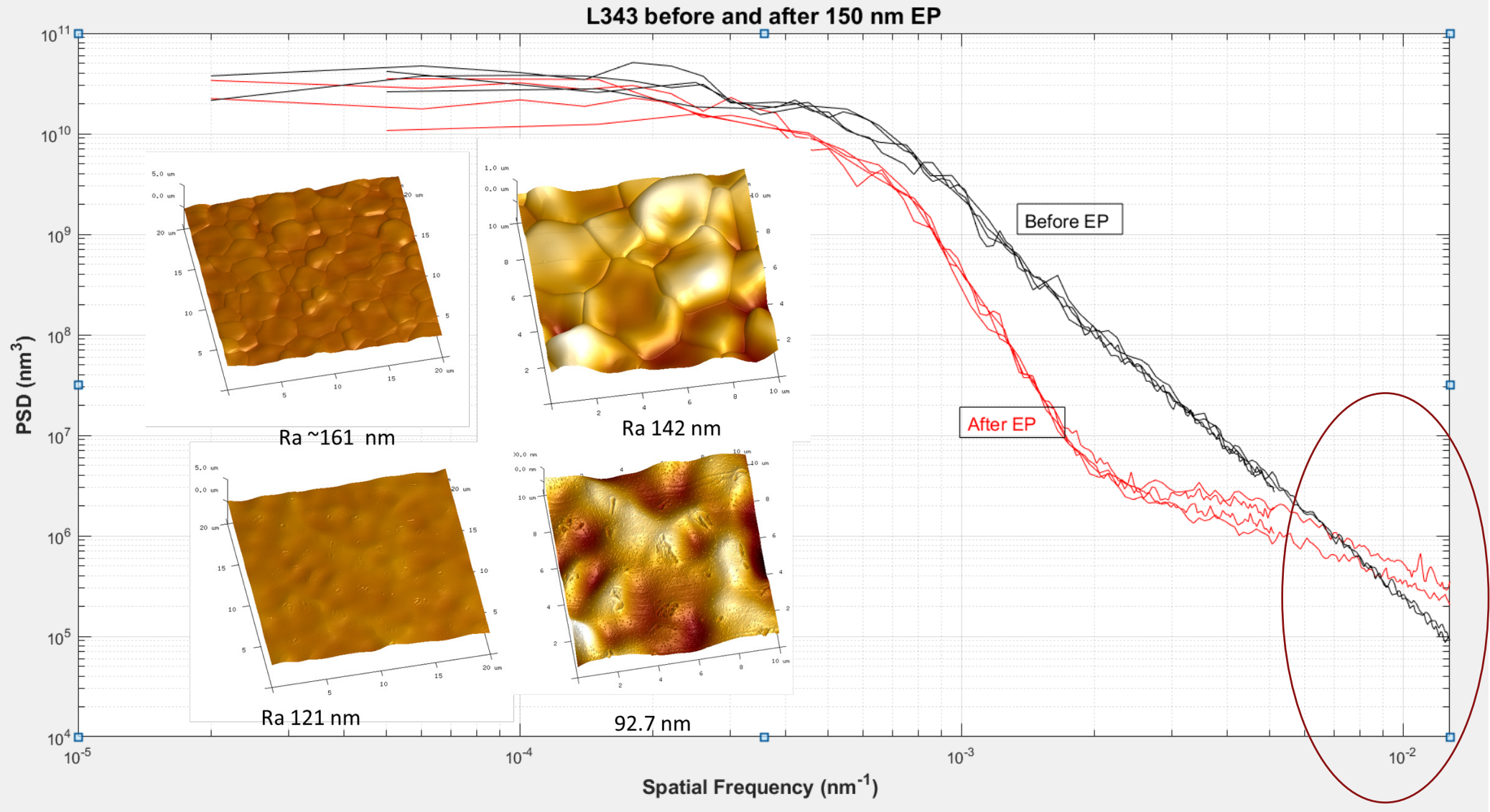


Measurement of surface roughness,  $R_a$ , as a function of grain size. (b) Relative frequency of the magnetic field enhancement factor calculated from AFM topographies using a perfect electrical conductor model. The colors shared between (a) and (b) indicate measurements derived from the same AFM topography

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# **Post-coating treatments for Roughness Reduction**

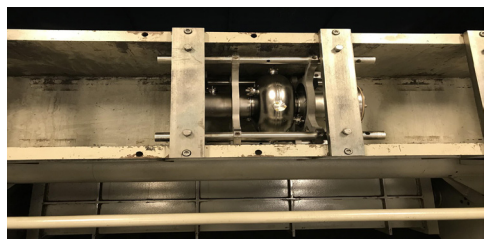
# Electropolishing



- 9 V resulting in current density  $\sim 20 \text{ mA/cm}^2$  at  $11^\circ\text{C}$ .
- Electrolyte 1:10 ratio of 49% HF to 98%  $\text{H}_2\text{SO}_4$ .

# Roughness Reduction - Fermilab

- The Centrifugal Barrel Polishing method (CBP) used commonly to smooth Nb cavities has been adapted to smooth Nb<sub>3</sub>Sn coated cavities
- Nanoparticle abrasive suspension (40 nm silicate or 50nm alumina particles) plus (0.25" wooden ball or 0.5" felt cube)
- 120 RPM in the barrel polishing machine



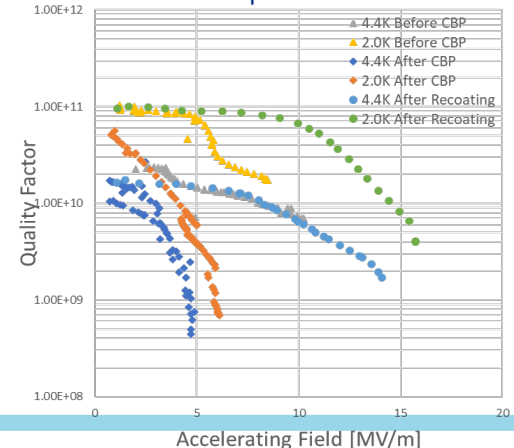
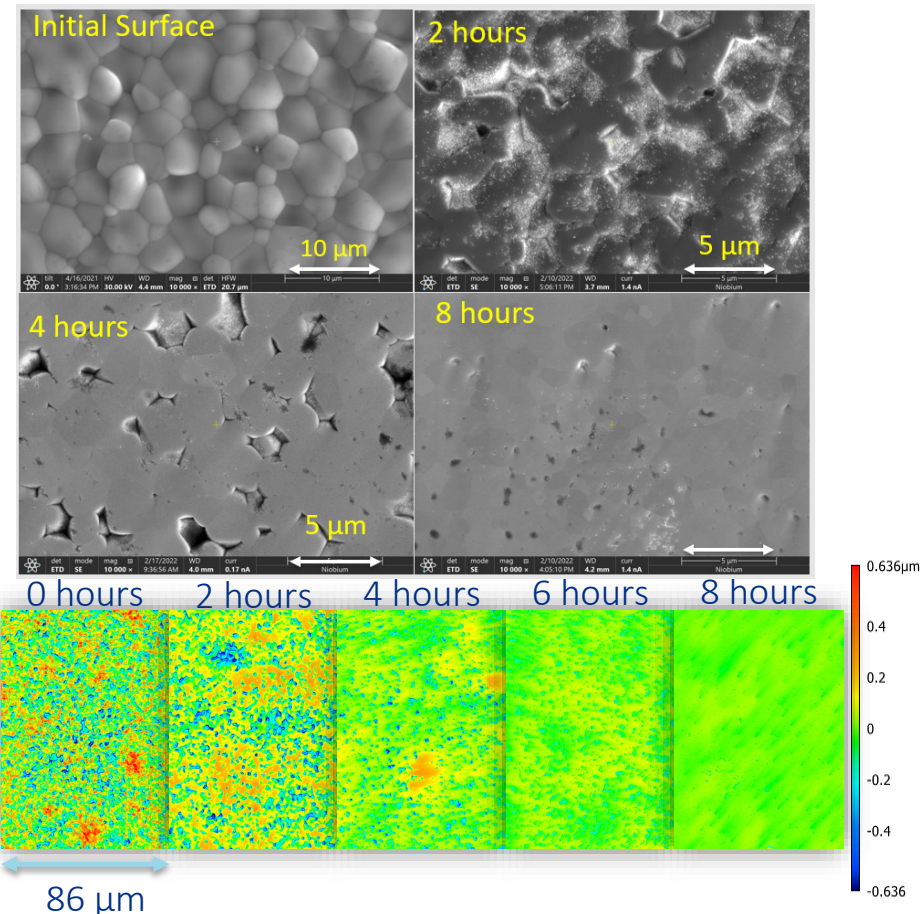
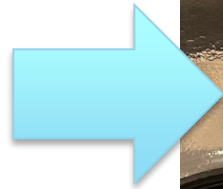
Before Coating



After Coating



After Polishing



Cavity performance was improved after CBP followed by a short recoating procedure

# Summary and Outlook

- Micro-roughness of Nb<sub>3</sub>Sn should be managed to improve RF performance.
- Pre-deposition of Sn layer promising to mitigate roughness
  - creation of high-density nucleation centers
    - ↳ plan to coat 2.45/2.6 GHz cavity
- Thicker coating ↔ increased grain size → higher surface roughness
  - ↳ vary coating parameters like time & temperature & Sn-flux etc.
- 1<sup>st</sup> coating of single-cell w/ new parameters
  - asymmetric coating with patchy regions and shiny features
  - limited to 19 MV/m
- Reduced roughness typically yields higher gradients!
- EP produces smoother Nb<sub>3</sub>Sn surface, but more studies needed to understand the surface defect.
- Significant efforts are in progress in different laboratories aiming at smoother Nb<sub>3</sub>Sn thin film.

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